### LCD / LCM SPECIFICATION



# WINSTAR Display Co.,Ltd. 華凌光電股份有限公司



### **SPECIFICATION**

### **CUSTOMER** :

MODULE NO.: WH1604A2-YYH-CW#

APPROVED BY:		
(FOR CUSTOMER USE ONLY)	PCB VERSION:	DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2020/12/08		First issue

	nstar Displa 凌光電股份有限		MODLE NO :	
REC	ORDS OF REV	<b>VISION</b>		DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.		SUMMARY
0	2020/12/08		Fi	rst issue

## Contents

- 1. Module Classification Information
- 2.Precautions in use of LCD Modules
- **3.General Specification**
- 4. Absolute Maximum Ratings
- **5.**Electrical Characteristics
- **6.Optical Characteristics**
- 7.Interface Pin Function
- 8.Contour Drawing &Block Diagram
- 9. Character Generator ROM Pattern
- 10.Reliability
- 11.Backlight Information
- 12.Inspection specification
- 13. Material List of Components for RoHs
- 14.Recommendable Storage
- 15.Other

### **1.Module Classification Information**

W	H	1604	<u>A2</u>	—	<u>Y</u>	<u>Y</u>	<u>H</u>	—	<u>CW#</u>
1	2	3	4		5	6	$\bigcirc$		8

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type : H→Character Type, G→Graphic Type, T→TAB Type

③ Display Font : Character 16 words, 04 Lines.

④ Model serials no.

5	Backlight	$N \rightarrow Without backlight T \rightarrow$		, White	$L \rightarrow LED$ , Full color			
	Type:	$B \rightarrow EL$ , Blue green	A→LED	, Amber	J→DIP LED,Blue			
		D→EL, Green	R→LED	, Red	$K \rightarrow DIP LED, White$			
		$W \rightarrow EL$ , White	O→LED	, Orange	$E \rightarrow DIP LED$ , Yellow Green			
		M→EL, Yellow Green	G→LED	, Green	H→DIP LED,Amber			
		$F \rightarrow CCFL$ , White	P→LED	, Blue	$I \rightarrow DIP LED, Red$			
		$Y \rightarrow LED$ , Yellow Green	X→LED	, Dual color				
		$G \rightarrow LED$ , Green	C→LED	, Full color				
6	LCD Mode :	B→TN Positive, Gray		V→FSTN	Negative, Blue			
		N→TN Negative,		T→FSTN	Negative, Black			
		$L \rightarrow VA$ Negative		$D \rightarrow FSTN$ Negative (Double film)				
	H→ HTN Positive, Gray		$F \rightarrow FSTN$ Positive					
		I→HTN Negative, Black		$K \rightarrow FSC$ Negative				
		U→HTN Negative, Blue		$S \rightarrow FSC Pc$	ositive			
		$M \rightarrow STN$ Negative, Blue		E→ISTN ]	Negative, Black			
		G→STN Positive, Gray		C→CSTN	Negative, Black			
		Y→STN Positive, Yellow	v Green	A→ASTN	Negative, Black			
$\bigcirc$	LCD Polarizer	$A \rightarrow Reflective, N.T, 6:00$	)	H→Transfle	ctive, W.T,6:00			
	Type/	$D \rightarrow Reflective, N.T, 12:0$	0	K→Transfle	ctive, W.T,12:00			
	Temperature	$G \rightarrow Reflective, W. T, 6:0$	0	C→Transmi	ssive, N.T,6:00			
	range/ View	$J \rightarrow Reflective, W. T, 12:0$	0	F→Transmis	ssive, N.T,12:00			
	direction	$B \rightarrow$ Transflective, N.T,6:	00	I→Transmis	sive, W. T, 6:00			
		$E \rightarrow$ Transflective, N.T.12	:00	L→Transmi	ssive, W.T,12:00			
8	Special Code	CW:English and Cyrillic	standard f	font				
		#:Fit in with the ROHS I	Directions	and regulatio	ns			

### **2.Precautions in use of LCD Modules**

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9)Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

## **3.General Specification**

Item	Dimension	Unit
Number of Characters	16 characters x 4Lines	—
Module dimension	87.0 x 60.0 x 13.6 (MAX)	mm
View area	62.0 x 26.0	mm
Active area	56.2 x 20.8	mm
Dot size	0.55 x 0.55	mm
Dot pitch	0.60 x 0.60	mm
Character size	2.95 x 4.75	mm
Character pitch	3.55 x 5.35	mm
LCD type	STN Positive, Yellow Green, Transflective (In LCD production, It will occur slightly color of can only guarantee the same color in the same ba	
Duty	1/16	
View direction	6 o'clock	
Backlight Type	LED Yellow Green	
IC	RW1063	
Interface	IIC	

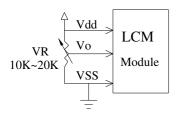
## **4.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T <sub>OP</sub>	-20	_	+70	°C
Storage Temperature	T <sub>ST</sub>	-30		+80	°C
Input Voltage	V <sub>IN</sub>	-0.3	_	V <sub>DD</sub> +0.3	V
Supply Voltage For Logic	VDD-V <sub>SS</sub>	-0.3		5.5	V
Supply Voltage For LCD	V <sub>DD</sub> -V <sub>0</sub>	V <sub>SS</sub> -0.3		V <sub>SS</sub> +7.0	V

## **5.Electrical Characteristics**

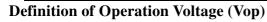
Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	$V_{DD}$ - $V_{SS}$		4.5	5.0	5.5	V
		Ta=-20°C	_	_	5.7	V
Supply Voltage For LCD	V <sub>OP</sub>	Ta=25℃	4.2	4.35	4.5	V
*Note		Ta=70°C 3.7		_	_	V
Input High Volt.	V <sub>IH</sub>	_	2.5		V <sub>DD</sub>	V
Input Low Volt.	V <sub>IL</sub>		-0.3		0.6	V
Output High Volt.	V <sub>OH</sub>	_	3.9		V <sub>DD</sub>	V
Output Low Volt.	V <sub>OL</sub>				0.4	V
Supply Current	I <sub>DD</sub>	V <sub>DD</sub> =5.0V	1.0	1.2	1.5	mA

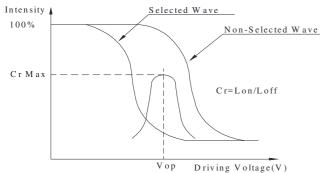
\* Note: Please design the VOP adjustment circuit on customer's main board

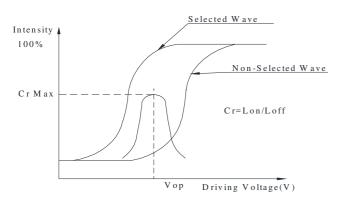


### **6.Optical Characteristics**

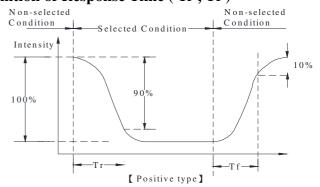
Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	$CR \ge 2$	0	—	20	$\phi = 180^{\circ}$
View Angle	θ	$CR \ge 2$	0	_	40	$\phi = 0^{\circ}$
	θ	$CR \ge 2$	0	—	30	$\phi = 90^{\circ}$
	θ	$CR \ge 2$	0	—	30	$\phi = 270^{\circ}$
Contrast Ratio	CR	_		3	_	_
	T rise	_		150	200	ms
Response Time	T fall	_		150	200	ms

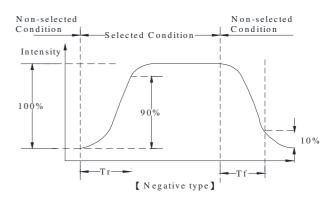






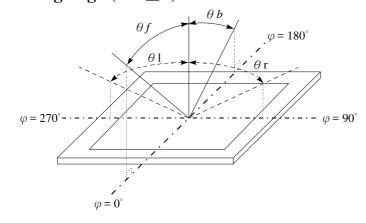
Definition of Response Time (Tr, Tf)





#### **Conditions :**

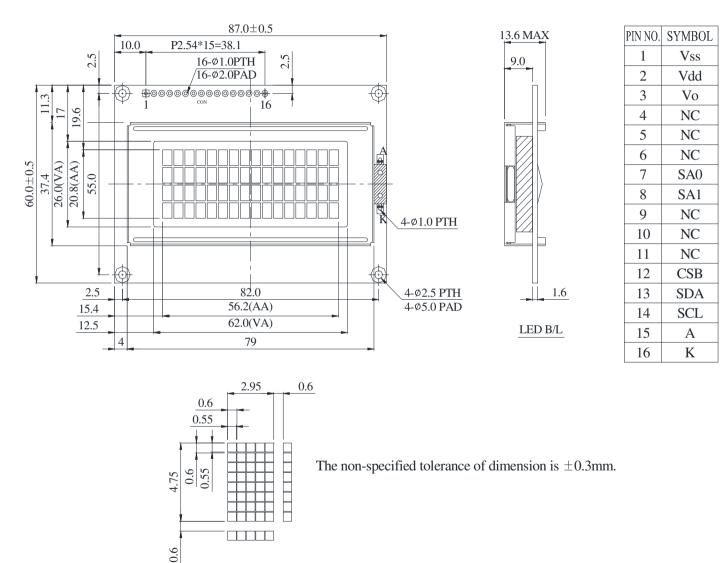
Operating Voltage : Vop Frame Frequency : 64 HZ **Definition of viewing angle**( $CR \ge 2$ ) Viewing Angle( $\theta$ ,  $\varphi$ ): 0°, 0° Driving Waveform: 1/N duty, 1/a bias



# **7.Interface Pin Function**

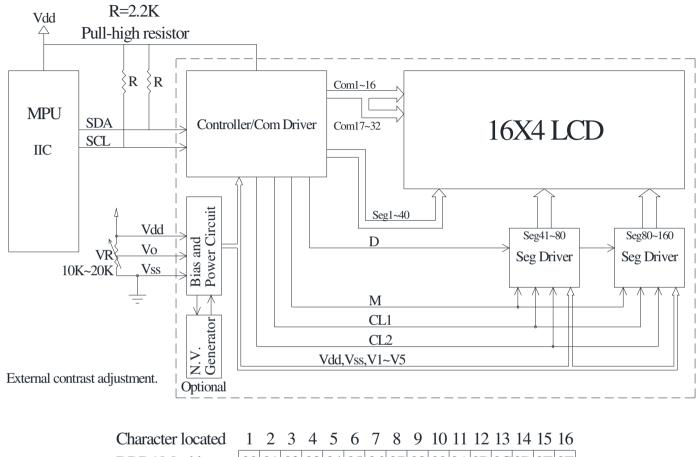
Pin No.	Symbol	Level	Description
1	V <sub>SS</sub>	0V	Ground
2	$V_{\text{DD}}$	5V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	NC	_	No connection
5	NC	_	No connection
6	NC	_	No connection
7	SA0	H/L	In IIC interface ,DB1(SA1) and DB0(SA0) are used
8	SA1	H/L	for Slave address, must be connect to VDD or VSS
9	NC	—	No connection
10	NC	_	No connection
11	NC	_	No connection
12	CSB	H/L	In IIC serial mode, used as chip selection input. When CSB = "Low", selected When CSB = "High", not selected. ( Low access enable )
13	SDA	H/L	serial input data
14	SCL	H/L	serial clock input
15	А	_	LED+
16	K	_	LED-

### **8.Contour Drawing & Block Diagram**



DOT SIZE SCALE 5/1

**WINSTAR** 



Character located	I	Z	3	4	3	0	/	0	9	10	11	12	13	14	13	10
DDRAM address	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
DDRAM address	40	41	42	43	44	45	46	47	48	49	4A	4 <b>B</b>	4C	4D	4E	4F
DDRAM address	10	11	12	13	14	15	16	17	18	19	1A	1 <b>B</b>	1C	1D	1E	1F
DDRAM address	50	51	52	53	54	55	56	57	58	59	5A	5B	5C	5D	5E	5F

### **9.Character Generator ROM Pattern**

Table.2

<u>b7~4</u> b3~0	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
b3~0	CG															
0000	RAM [00]															
0001	CG RAM [01]															
0010	CG RAM [02]															
0011	CG RAM [03]															
0100	CG RAM [04]															
0101	CG RAM [05]															
0110	сс кам [06]		8									*				
0111	СС RAM [07]															
1000	CG RAM [00]															
1001	CG RAM [01]															
1010	CG RAM [02]															
1011	CG RAM [03]															
1100	сс кам [04]															
1101	CG RAM [05]															8
1110	CG RAM [06]															
1111	CG RAM [07]															

# **10.Reliability**

Content of Reliability Test (Wide temperature, -20°C~70°C)

	<b>Environmental Test</b>		
Test Item	Content of Test	Test Condition	Not e
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60 $^{\circ}$ C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C ,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation $-20^{\circ}C$ $25^{\circ}C$ $70^{\circ}C$ 30min 5min 30min	-20°C/70°C 10 cycles	
Vibration test	1 cycle Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

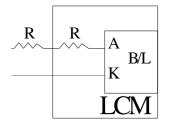
# **11.Backlight Information**

#### Specification

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNIT	TEST CONDITION
Supply Current	ILED	198	220	264	mA	V=4.2V
Supply Voltage	V	4.0	4.2	4.4	V	-
Reverse Voltage	VR	_	_	8	V	-
Luminance (Without LCD)	IV	160	200	_	CD/M <sup>2</sup>	ILED=220mA
Wave Length	λp	568	570	575	nm	ILED=220mA
I : £ . T:			100000		II	ILED≦220 mA
Life Time			100000		Hr.	25°C,50-60%RH
Color	Yellow Gre	en				

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

2.Drive from pin15,pin16

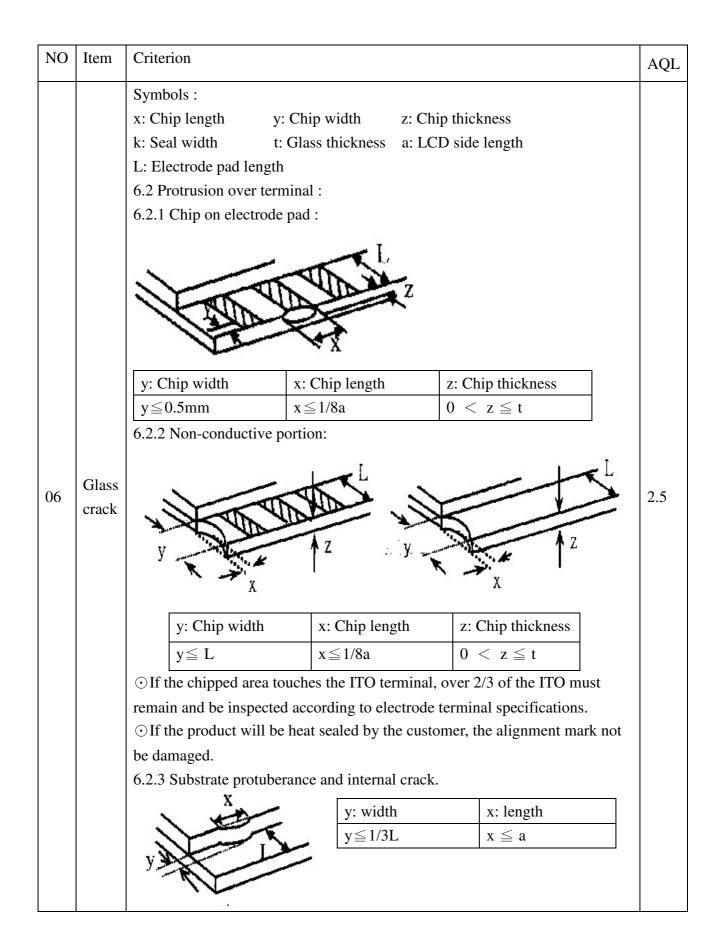


ill never get Vee output from pin15)

## **12.Inspection specification**

NO	Item	Criterion				AQL
		Missing vertica	l, horizont	al segment, segmen	nt contrast defect.	
		Missing charact	ter , dot or	icon.		
		Display malfun	ction.			
01	Electrical	No function or	no display			0.65
01	Testing	Current consum	nption exc	eeds product specif	ications.	0.05
		LCD viewing a	ngle defec	et.		
		Mixed product	• 1			
		Contrast defect	•			
	Black or	2.1 White and b	black spots	s on display $\leq 0.25$	mm, no more than	
02	white spots on	three white or b	-			2.5
	LCD (display	2.2 Densely spa	aced: No n	nore than two spots	or lines within 3mm	
	only)					
		3.1 Round type	: As follo	wing drawing		
		$\Phi = (x + y)/2$	Γ	SIZE	Accontable O TV	
		x	-	Δ≦0.10	Acceptable Q TY Accept no dense	
		→ <b>→</b> <sup>ˆ</sup> <del>  </del> →	. ↓	$0.10 < \Phi \le 0.20$	2	2.5
			TY Y	$0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$	1	
	LCD black		T -	$0.25 < \Phi$ $0.25 < \Phi$	0	
	spots, white		L	$0.25 \smallsetminus \Phi$	0	
03	spots,	3.2 Line type :	(As follow	ving drawing)		
	contamination	<b>71</b>	Length	Width	Acceptable Q TY	
	(non-display)	∽ /¥ w		W≦0.02	Accept no dense	
			L≦3.0	$0.02 < W \le 0.03$		2.5
			L≦2.5	$0.03 < W \le 0.05$	2	2.5
				0.05 < W	As round type	
		If bubbles are v	visible,	Size Φ	Acceptable Q TY	
	Polarizer	judge using bla	-	$\Phi \leq 0.20$	Accept no dense	
04	bubbles	specifications, i	-	$0.20 < \Phi \le 0.50$	3	2.5
		to find, must ch		0.50<Φ≦1.00	2	
		specify directio	n.	<u>1.00&lt;Φ</u>	0	
				Total Q TY	3	

	Item	Criterion			AQL
05	Scratches	Follow NO.3 LCD bl	ack spots, white spots, c	contamination	
		Symbols Define: x: Chip length k: Seal width L: Electrode pad leng 6.1 General glass chip	y: Chip width z: C t: Glass thickness a: I th:	Chip thickness LCD side length	
06	Chipped glass	z: Chip thickness $Z \leq 1/2t$ $1/2t < z \leq 2t$	y: Chip width Not over viewing area Not exceed 1/3k	x: Chip length $x \le 1/8a$ $x \le 1/8a$	2.5
		⊙ If there are 2 or mo 6.1.2 Corner crack:	re chips, x is total lengt	h of each chip.	
			re chips, x is total lengt y: Chip width Not over viewing area	h of each chip. x: Chip length $x \le 1/8a$	



NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
		8.1 Illumination source flickers when lit.	0.65
08	Backlight elements	8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards.	2.5
		8.3 Backlight doesn't light or color wrong.	0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.	2.5
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	2.5
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height indicated in the assembly diagram.	0.65
		10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.	2.5
		10.5 No oxidation or contamination PCB terminals.	2.5
10	PCB、COB	10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.	0.65
		10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5
		$\mathbf{Y}$ X * Y<=2mm <sup>2</sup>	
		11.1 No un-melted solder paste may be present on the PCB.	2.5
11	Soldering	11.2 No cold solder joints, missing solder connections, oxidation or icicle.	2.5
	solucing	11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

# <u>13.Material List of Components for</u> <u>RoHs</u>

 WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm
Above limi	ted va	lue is s	set up a	accordi	ng to F	RoHS.				

2.Process for RoHS requirement : (only for RoHS inspection)

- (1) Use the Sn/Ag/Cu soldering surface ; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow :  $250^{\circ}$ C, 30 seconds Max. ;

Connector soldering wave or hand soldering  $: 320^{\circ}$ C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. :  $235\pm5^{\circ}C$ ;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.

## **14.Recommendable Storage**

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

dule Number :	<u> </u>	Page: 1
► Panel Specification <sup>:</sup>		
1. Panel Type :	Pass	□ NG ,
2. View Direction :	Pass	□ NG ,
3. Numbers of Dots :	Pass	□ NG ,
4. View Area :	Pass	□ NG ,
5. Active Area :	Pass	□ NG ,
6. Operating Temperature :	Pass	□ NG ,
7. Storage Temperature :	Pass	□ NG ,
8. Others :		
<b>∧ <u>Mechanical Specification</u> :</b>		
1. PCB Size :	Pass	□ NG ,
2. Frame Size :	Pass	□ NG ,
3. Materal of Frame :	Pass	□ NG ,
4. Connector Position :	Pass	□ NG ,
5. Fix Hole Position :	Pass	□ NG ,
6. Backlight Position :	Pass	□ NG ,
7. Thickness of PCB :	Pass	□ NG ,
8. Height of Frame to PCB :	Pass	□ NG ,
9. Height of Module :	Pass	□ NG ,
10. Others :	Pass	□ NG ,
Relative Hole Size :		
1. Pitch of Connector :	Pass	□ NG ,
2. Hole size of Connector :	Pass	□ NG ,
3. Mounting Hole size :	Pass	□ NG ,
4. Mounting Hole Type :	Pass	□ NG ,
5. Others :	Pass	□ NG ,
<u>Backlight Specification</u> :		
1. B/L Type :	Pass	□ NG ,
2. B/L Color :	Pass	□ NG ,
3. B/L Driving Voltage (Refere	nce for LED T	$Fype): \square Pass \square NG, \_$
4. B/L Driving Current :	Pass	□ NG ,
5. Brightness of B/L :	Pass	□ NG ,
6. B/L Solder Method :	Pass	□ NG ,
7. Others :	<b>Pass</b>	□ NG ,



#### winstar

#### Module Number : \_\_\_\_\_

- 1. Input Voltage :

   Pass
- 2. Supply Current :
- Driving Voltage for LCD : Pass
   Contrast for LCD : Pass
- 5. B/L Driving Method :

   Pass
- 7. Interface Function :

Pass

Pass

Pass

- 8. LCD Uniformity :
- 9. ESD test :
- 10. Others :

#### 6 · <u>Summary</u> :

#### Page: 2

□ NG ,
□ NG ,

Sales signature : \_\_\_\_\_

Customer Signature :

|--|

# **15.Other (IC Information)**

### **1.Function Description**

#### SYSTEM INTERFACE (Parallel 8-bit bus and 4-bit bus)

This chip has all four kinds interface type with MPU: IIC, 4SPI, 4-bit bus and 8-bit bus. Serial and parallel buses (4-bit/8-bit) are selected by IF1 and IF0 input pins, and 4-bit bus and 8-bit bus is selected by DL bit in the instruction register.

During read or write operation, two 8-bit registers are used. One is data register (DR); the other is instruction register (IR). The data register (DR) is used as temporary data storage place for being written into or read from DDRAM/CGRAM, target RAM is selected by RAM address setting instruction. Each internal operation, reading from or writing into RAM, is done automatically.

So to speak, after MPU reads DR data, the data in the next DDRAM/CGRAM address is transferred into DR automatically. Also after MPU writes data to DR, the data in DR is transferred into DDRAM/CGRAM automatically.

The Instruction register (IR) is used only to store instruction code transferred from MPU. MPU cannot use it to read instruction data.

IR: Instruction Register.

DR: Data Register.

RS	R/W	Operation
0	0	Instruction write operation (MPU writes Instruction code into IR)
0	1	Read busy flag (DB7) and address counter (DB0 - DB6)
1	0	Data write operation (MPU writes data into DR
1	1	Data read operation (MPU reads data from DR)

#### BUSY FLAG (BF) (only support parallel 8-bit bus and 4-bit bus)

When BF = "High", it indicates that the internal operation is being processed. So during this time the next instruction cannot be accepted. BF can be read, when RS = Low and R / W = High (Read Instruction Operation); through DB7 before executing the next instruction, be sure that BF is not High.

#### DISPLAY DATA RAM (DDRAM)

DDRAM stores display data of maximum 80 x 8 bits (80 characters). DDRAM address is set in the address counter (AC) as a hexadecimal number. (Refer to Figure 1.)

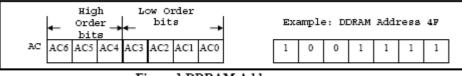


Figure 1 DDRAM Address

Since DDRAM has 8 bits data. It is possible to access 256 CGROM/CGRAM fonts.

1-line display (N = 0) (Figure 2)

**WINSTAR** 

When there are fewer than 80 display characters, the display begins at the head position. For example, if using only the Controller, 8 characters are displayed. See Figure 3.

When the display shift operation is performed, the DDRAM address shifts. See Figure 3.

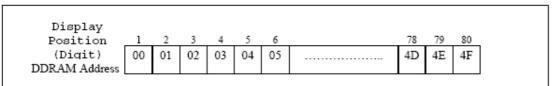


Figure 2 1-Line Display

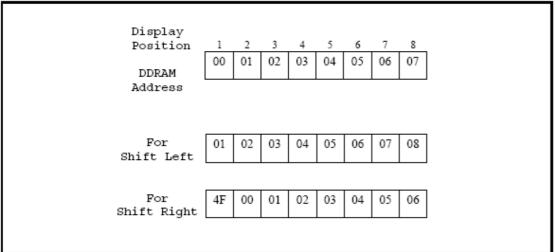


Figure 3 1-Line by 8-Character Display Example

#### 2-line display (N = 1) (Figure 4)

Case 1: When the number of display characters is less than 40 x 2 lines, the two lines are displayed from the head. Note that the first line end address and the second line start address are not consecutive. For example, when just the Controller is used, 8 characters x 2 lines are displayed. See Figure 5. When display shift operation is performed, the DDRAM address shifts. See Figure 5.

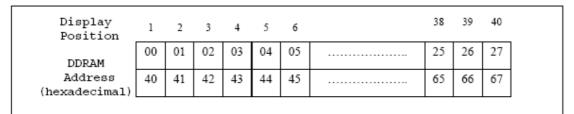


Figure 4 2-Lines Display

Display Position	1	2	3	4	5	6	7	8	
DDRAM	00	01	02	03	04	05	06	07	
Address	40	41	42	43	44	45	46	47	
· · · · · · · · · · · · · · · · · · ·									1
For	01	02	03	04	05	06	07	08	
Shift Left	41	42	43	44	45	46	47	48	
									1
For Shift Right	27	00	01	02	03	04	05	06	]
	67	40	41	42	43	44	45	46	

Figure 5 2-Lines by 8-Character Display Example

Case 2: For a 16-character x 2-line display, the Controller can be extended using one 40-output extension driver. See Figure 6.

When display shift operation is performed, the DDRAM address shifts. See Figure 6.

Display	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
Position DDRAM	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
Address	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F
										1						
For Shift	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F	10
Left	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F	50
For Shift	27	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E
Right	67	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E

Figure 6 2-Lines by 16-Character Display Example

#### TIMING GENERATION CIRCUIT

Timing generation circuit generates clock signals for the internal operations.

#### **ADDRESS COUNTER (AC)**

Address Counter (AC) stores DDRAM/CGRAM address, transferred from IR.

After writing into (reading from) DDRAM/CGRAM/SEGRAM, AC is automatically increased (decreased) by 1.

When RS = "Low" and R/W = "High", AC can be read through DB0-DB6

#### **CURSOR/BLINK CONTROL CIRCUIT**

It controls cursor/blink ON/OFF and black/white inversion at cursor position.

#### LCD DRIVER CIRCUIT

LCD Driver circuit has 16 common and 40 segment signals for 2-line display (N=1) or 8 common and 40 segments for 1-line display (N=0) for LCD driving.

Data from CGRAM/CGROM is transferred to 40 bit segment latches serially, and then it is stored to 40 bit shift latch.

#### CGROM (CHARACTER GENERATOR ROM)

CGROM has 10,240 bits (256 characters x 5 x 8 dot)

#### CGRAM (CHARACTER GENERATOR RAM)

CGRAM has up to 5 8 dots 8 characters. By writing font data to CGRAM, user defined character can be used (refer to Table 2).

#### 5 x 8 dots Character Pattern

#### Table 2. Relationship between Character Code (DDRAM) and Character Pattern (CGRAM)

	Char	acter	Code	e (DD	RAN	I data	)		CC	GRAN	í Add	lress				0	GRA	M D	ata			Pattern
D7	D6	D5	D4	D3	D2	D1	D0	Α5	A4	A3	A2	A1	A0	P7	P6	P5	P4	P3	P2	P1	PO	Number
0	0	0	0	0	0	0	0	0	0	0	0	0	0	Х	Х	Х	0	1	1	1	0	Pattern 1
-	-	-	-	-	0	0	0	-	-	-	0	0	1	-	-	-	1	0	0	0	1	
-	-	-	-	-	0	0	0	-	-	-	0	1	0	-	-	-	1	0	0	0	1	
-	-	-	-	-	0	0	0	-	-	-	0	1	1	-	-	-	1	1	1	1	1	
-	-	-	-	-	0	0	0	-	-	-	1	0	0	-	-	-	1	0	0	0	1	
-	-	-	-	-	0	0	0	-	-	-	1	0	1	-	-	-	1	0	0	0	1	
-	-	-	-	-	0	0	0	-	-	-	1	1	0	-	-	-	1	0	0	0	1	
-	-	-	-	-	0	0	0	-	-	-	1	1	1	-	-	-	0	0	0	0	0	
				-					-			-						-				
				-					-			-						-				
0	0	0	0	0	1	1	1	1	1	1	0	0	0	Х	Х	Х	1	0	0	0	1	Pattern 8
-	-	-	-	-	1	1	1	-	-	-	0	0	1	-	-	-	1	0	0	0	1	
-	-	-	-	-	1	1	1	-	-	-	0	1	0	-	-	-	1	0	0	0	1	
-	-	-	-	-	1	1	1	-	-	-	0	1	1	-	-	-	1	1	1	1	1	
-	-	-	-	-	1	1	1	-	-	-	1	0	0	-	-	-	1	0	0	0	1	
-	-	-	-	-	1	1	1	-	-	-	1	0	1	-	-	-	1	0	0	0	1	
-	-	-	-	-	1	1	1	-	-	-	1	1	0	-	-	-	1	0	0	0	1	
-	-	-	-	-	1	1	1	-	-	-	-1	1	1	-	-	-	0	0	0	0	0	

Notes:

1. Character code bits 0 to 2 correspond to CGRAM address bits 3 to 5 (3 bits: 8 types).

2. CGRAM address bits 0 to 2 designate the character pattern line position. The 8th line is the cursor position and its display is formed by a logical OR with the cursor. Maintain the 8th line data, corresponding to the cursor display position, at 0 as the cursor display. If the 8th line data is 1, 1 bit will light up the 8th line regardless of the cursor presence.

3. Character pattern row positions correspond to CGRAM data bits 0 to 4 (bit 4 being at the left).

4. As shown Table 2, CGRAM character patterns are selected when character code bits 4 to 7 are all 0 and MW=0. However, since character code bit 3 has no effect, the H display example above can be selected by either character code 00H or 08H.

5. 1 for CGRAM data corresponds to display selection and 0 to non-selection.

"-": Indicates no effect.

Instruction	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	Description Time (540KHz)
Read display data	1	1				Read	l data				Read data into DDRAM/CGRAM/SEGRAM	18.5us
Write display data	1	0				Write	e data				Write data into DDRAM/CGRAM/SEGRAM	18.5us
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM, and set DDRAM address to "00H" from AC	0.76ms
Return Home	0	0	0	0	0	0	0	0	1	Х	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	0.76ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D		Assign cursor moving direction and specify display shift. These operations are performed during data read and write. I/D="1": increment I/D="0": decrement	18.5us
Display ON/OFF	0	0	0	0	0	0	1	D	С	В	Set Display /Cursor/Blink On/OFF D="1": display on D="0": display off C="1": cursor on C="0": cursor off B="1": blink on B="0": blink off	18.5us
Cursor or Display shift	0	0	0	0	0	1	S/C	R/L	Х	Х	Cursor or display shift S/C="1": display shift S/C="0": cursor shift R/L="1": shift to right R/L="0": shift to left	18.5us
Function Set	0	0	0	0	1	DL	N	F	Х		Set Interface Data Length DL= 8-bit interface/ 4-bit interface N = 2-line/1-line display F= 5x8 Font Size / 5x11Font Size	18.5us
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter	18.5us
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter	18.5us
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Can know internal operation is ready or not by reading BF. The contents of address counter can also be read. BF="1": busy state BF="0": ready state	Ous

_										
R	s	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	)	0	0	0	0	0	0	0	0	1

Clear all the display data by writing "20H" (space code) to all DDRAM address, and set DDRAM address to "00H" into AC (address counter). Return cursor to the original status; namely, bring the cursor to the left edge on first line of the display. Make entry mode increment (I/D = "1").

#### **Return Home:**

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	0	1	Х

Return Home is cursor return home instruction. Set DDRAM address to "00H" into the address counter. Return cursor to its original site and return display to its original status, if shifted. A content of DDRAM does not change.

#### **Entry Mode Set:**

_	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
	0	0	0	0	0	0	0	1	I/D	S

Set the moving direction of cursor and display.

#### I/D: Increment/decrement of DDRAM address (cursor or blink)

I/D = 1: cursor/blink moves to right and DDRAM address is increased by 1.

I/D = 0: cursor/blink moves to left and DDRAM address is decreased by 1.

\* CGRAM operates the same as DDRAM, when read/write from or to CGRAM

#### S: Shift of entire display

When DDRAM read (CGRAM read/write) operation or S = "Low", shift of entire display is not performed.

If S= "High" and DDRAM write operation, shift of entire display is performed according to I/D value (I/D = "1": shift left, I/D = "0": shift right).

s	I/D	Description
Н	Н	Shift the display to the left
Н	L	Shift the display to the right

#### **Display ON/OFF**

1	D	С	В

Control display/cursor/blink ON/OFF 1 bit register.

#### **D:** Display ON/OFF control bit.

D = 1: entire display is turned on.

D = 0: display is turned off, but display data is remained in DDRAM.

**C: Cursor ON/OFF control bit.** 

#### **N** WINSTAR

C = 1: cursor is turned on.

C = 0: cursor is disappeared in current display, but I/D register remains its data.

#### **B:** Cursor Blink ON/OFF control bit.

B = 1: cursor blink is on, that performs alternate between all the high data and display character at the cursor position. If fosc has 540 kHz frequency, blinking has 185 ms interval.

B = 0: blink is off.

#### **Cursor or Display Shift**

_	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
[	0	0	0	0	0	1	S/C	R/L	-	-

Without writing or reading of display data, shift right/left cursor position or display. This instruction is used to correct or search display data (refer to Table 4). During 2-line mode display, cursor moves to the 2nd line after 40th digit of 1st line.

Note that display shift is performed simultaneously by the shift enable instruction. When displayed data is shifted repeatedly, all display lines shifted simultaneously. When display shift is performed, the contents of address counter are not changed.

#### Table 4. Shift Patterns According to S/C and R/L Bits

S/C	R/L	Operation
0	0	Shift cursor to the left, address counter is decreased by 1
0	1	Shift cursor to the right, address counter is increased by 1
1	0	Shift all the display to the left, cursor moves according to the display
1	1	Shift all the display to the right, cursor moves according to the display

#### **Function Set**

_	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
	0	0	0	0	1	DL	Ν	F	X	Х

#### DL: Interface data length control bit

When DL = "High", it means 8-bit bus mode with MPU.

When DL = "Low", it means 4-bit bus mode with MPU. So to speak, DL is a signal to select 8-bit or 4-bit bus mode.

When 4-bit bus mode, it needs to transfer 4-bit data by two times.

IF using IIC and 4-SPI interface > DL bit must be setting to "1"

#### N: Display line number control bit

When N = "Low", it means 1-line display mode.

When N = "High", 2-line display mode is set.

#### **F:** Display font type control bit

When F = "Low", it means 5 x 8 dots format display mode

When F = "High", 5 x11 dots format display mode.

Ν	F	No. of Display Lines	Character Font	Duty Factor		
L	L	1	5x8	1/8		
L	Н	1	5x11	1/11		
Н	x	2	5x8	1/16		

#### Set CGRAM Address

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0

Set CGRAM address to AC.

This instruction makes CGRAM data available from MPU.

#### Set DDRAM Address

_	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0

Set DDRAM address to AC.

This instruction makes DDRAM data available from MPU.

When 1-line display mode (N=0), DDRAM address is from "00H" to "4FH"

In 2-line display mode (NW = 0), DDRAM address in the 1st line is from "00H" - "27H", and DDRAM address in the 2nd line is from "40H" - "67H".

#### Read Busy Flag and Address (only support parallel 8-bit bus and 4 bit bus)

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0

This instruction shows whether Controller is in internal operation or not. If the resultant BF is "high", it means the internal operation is in progress and you have to wait until BF to be Low, and then the next instruction can be performed. In this instruction you can read also the value of address counter.

#### Write Data to RAM

RS	;	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1		0	D7	D6	D5	D4	D3	D2	D1	D0

Write binary 8-bit data to DDRAM/CGRAM/SEGRAM.

The selection of RAM from DDRAM, CGRAM, is set by the previous address set instruction:

DDRAM address set, CGRAM address set. RAM set instruction can also determine the AC direction to RAM.

After write operation, the address is automatically increased/decreased by 1, according to the entry mode.

**Read Data from RAM** (only support parallel 8-bit bus and 4 bit bus)

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	1	D7	D6	D5	D4	D3	D2	D1	D0

Read binary 8-bit data from DDRAM/CGRAM.

The selection of RAM is set by the previous address set instruction. If address set instruction of RAM is not performed before this instruction, the data that read first is invalid, because the direction of AC is not determined.

If you read RAM data several times without RAM address set instruction before read operation, you can get correct RAM data from the second, but the first data would be incorrect, because there is no time margin to transfer RAM data.

In case of DDRAM read operation, cursor shift instruction plays the same role as DDRAM address set instruction: it also transfer RAM data to output data register. After read operation address counter is automatically increased/decreased by 1 according to the entry mode.

After CGRAM read operation, display shift may not be executed correctly.

\* In case of RAM write operation, after this AC is increased/decreased by 1 like read operation. In this time, AC indicates the next address position, but you can read only the previous data by read instruction.

#### OUTLINE

To overcome the speed difference between internal clock of Controller and MPU clock, Controller performs internal operation by storing control information to IR (Instruction Register) or DR (data Register).

The internal operation is determined according to the signal from MPU, composed of read/write and data bus.

I Nstruction can be divided largely four kinds;

\*Controller function set instructions (set display methods, set data length, etc.)

\*Address set instructions to internal RAM

\*Data transfer instructions with internal RAM

\*Others

The address of internal RAM is automatically increased or decreased by 1.

**NOTE:** During internal operation, Busy Flag (DB7) is read high. Busy Flag check must be preceded the next instruction.

Busy flag check must be proceeded the next instruction.

When an MPU program with Busy Flag (DB7) checking is made, 1/2 Fosc (is necessary) for executing the next instruction by the falling edge of the "E" signal after the Busy Flag (DB7) goes to "Low".

#### **INTERFACE WITH MPU**

Controller can transfer data in bus mode (4-bit or 8-bit) or serial mode with MPU.

In case of 4-bit bus mode, data transfer is performed by two times to transfer 1 byte data.

When interfacing data lengths are 4-bit, only 4 ports, from DB4 - DB7, are used as data bus. At first higher 4-bit (in case of 8-bit bus mode, the contents of DB4 - DB7) are transferred, and then lower 4- bit (in case of 8-bit bus mode, the contents of DB0 - DB3) are transferred. So transfer is performed by two times.

Busy Flag outputs "High" after the second transfer are ended.

When interfacing data length are 8-bit, transfer is performed at a time through 8 ports, from DB0 - DB7.

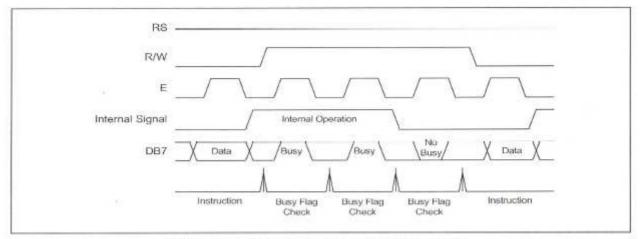
Interface is selected by IF1, IF0 pins (refer to Bonding Note for IF1, IF0 on Page 10)

IF1	IF0	Interface select		
open	open	6800 8/4 bit		
open	Bonding to VDD	IIC		
Bonding to VDD	open	4-line SPI		

#### INTERFACE WITH MPU IN BUS MODE

#### Interface with 8-bit MPU

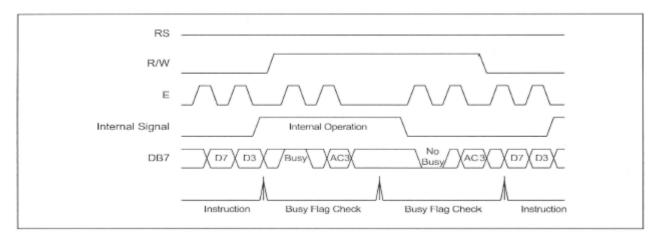
If 8-bits MPU is used, Controller can connect directly with that. In this case, port E, RS, R/W and DB0 to DB7 need to interface each other. Example of timing sequence is shown below.



Example of 8-bit Bus Mode Timing Sequence

#### Interface with 4-bit MPU

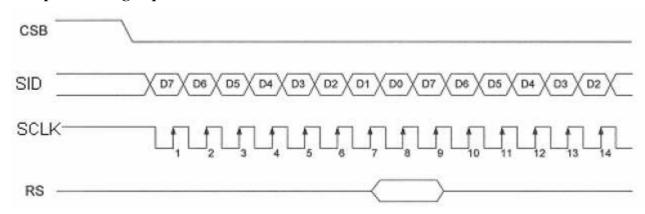
If 4-bit MPU is used, Controller can connect directly with this. In this case, port E, RS, R/W and DB4 - DB7 need to interface each other. The transfer is performed by two times. Example of timing sequence is shown below.



Example of 4-bit Bus Mode Timing Sequence

#### For serial interface data, bus lines (DB5 to DB7) are used. 4-Line SPI

If 4-Pin SPI mode is used, CSB (DB5), SID (DB7), SCLK (DB6), and RS are used. They are chip selection; serial input data, serial clock input, and data/instruction section, relatively. The example of timing sequence is shown below.



**Example of timing sequence** 

Note: Following is the master SPI clock mode of MPU.

Idle state for clock is a high level , data transmitted on rising edge of SCLK, and data is hold during low level.

#### For serial interface data, bus lines (DB5(CSB) $\smallsetminus$ DB6(SDA) and DB7(SCL)) are used.

#### **IIC interface**

The IIC interface receives and executes the commands sent via the IIC Interface. It also receives RAM data and sends it to the RAM.

The IIC Interface is for bi-directional, two-line communication between different ICs or modules. Serial data line

SDA (DB6) and a Serial clock line SCL (DB7) must be connected to a positive supply via a pull-up resistor.

Data transfer may be initiated only when the bus is not busy.

\*The CSB (DB5) Pin must be setting to "VSS".

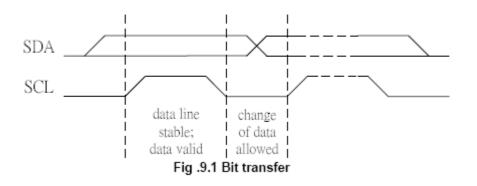
\* When IIC interface is selected, the DL register must be set to "1".

#### **BIT TRANSFER**

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the

HIGH period of the clock pulse because changes in the data line at this time will be interpreted as a control

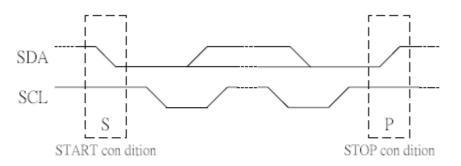
signal. Bit transfer is illustrated in Fig.9.1



#### START AND STOP CONDITIONS

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P). The START and STOP conditions are illustrated in

Fig.9.2





#### SYSTEM CONFIGURATION

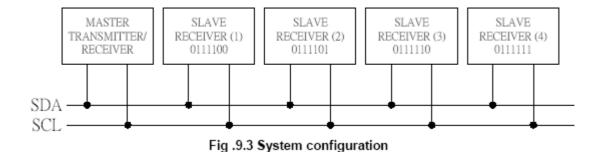
The system configuration is illustrated in Fig.9.3

- $\cdot$  Transmitter: the device, which sends the data to the bus
- $\cdot$  Receiver: the device, which receives the data from the bus
- $\cdot$  Master: the device, which initiates a transfer, generates clock signals and terminates a transfer
- $\cdot$  Slave: the device addressed by a master

 $\cdot$  Multi-Master: more than one master can attempt to control the bus at the same time without corrupting the message

 $\cdot$  Arbitration: procedure to ensure that, if more than one master simultaneously tries to control the bus, only one is allowed to do so and the message is not corrupted

 $\cdot$  Synchronization: procedure to synchronize the clock signals of two or more devices.



#### ACKNOWLEDGE

Each byte of eight bits is followed by an acknowledge bit. The acknowledge bit is a HIGH signal put on the bus by the transmitter during which time the master generates an extra acknowledge related clock pulse. A slave receiver which is addressed must generate an Acknowledge after the reception of each byte. A master receiver must also generate an Acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the Acknowledge related clock pulse (set-up and hold times must be taken into consideration). A master receiver must signal an end-of-data to the transmitter by not generating an Acknowledge on the last byte that has been clocked out of the slave. In this event the transmitter must leave the data line HIGH to enable the master to generate a STOP condition. Acknowledgement on the IIC Interface is illustrated in Fig.9.4

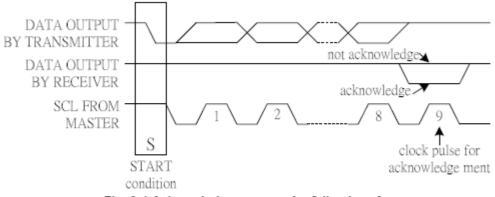


Fig .9.4 Acknowledgement on the 2-line Interface

#### **IIC Interface protocol**

The Controller supports command, data write addressed slaves on the bus.

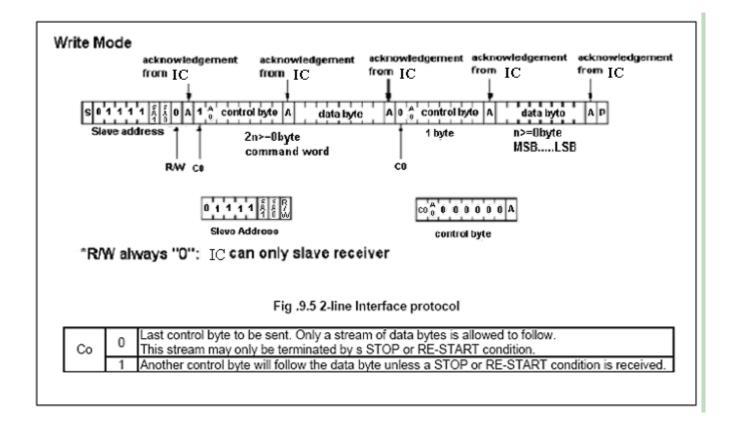
Before any data is transmitted on the IIC Interface, the device, which should respond, is addressed first. Four 7-bit slave addresses (0111100, 0111101, 0111110 and 0111111) are reserved for the Controller. The least significant bit of the slave address is set by connecting the input SA0 (DB0) and SA1 (DB1) to either logic 0 (VSS) or logic 1 (VDD).

The IIC Interface protocol is illustrated in Figure.9.5

The sequence is initiated with a START condition (S) from the IIC Interface master, which is followed by the slave address. All slaves with the corresponding address acknowledge in parallel, all the others will ignore the IIC Interface transfer. After acknowledgement, one or more command words follow which define the status of the addressed slaves.

A command word consists of a control byte, which defines Co and A0, plus a data byte.

The last control byte is tagged with a cleared most significant bit (i.e. the continuation bit Co). After a control byte with a cleared Co bit, only data bytes will follow. The state of the A0 bit defines whether the data byte is interpreted as a command or as RAM data. All addressed slaves on the bus also acknowledge the control and data bytes. After the last control byte, depending on the A0 bit setting; either a series of display data bytes or command data bytes may follow. If the A0 bit is set to logic 1, these display bytes are stored in the display RAM at the address specified by the data pointer. The data pointer is automatically updated and the data is directed to the intended Controller device. If the A0 bit of the last control byte is set to logic 0, these command bytes will be decoded and the setting of the device will be changed according to the received commands. Only the addressed slave makes the acknowledgement after each byte. At the end of the transmission the IIC interface-bus master issues a STOP condition (P). If no acknowledge is generated by the master after a byte, the driver stops transferring data to the master.



#### INITIALIZING INITIALIZING BY INTERNAL RESET CIRCUIT

When the power is turned on, Controller is initialized automatically by power on reset circuit.

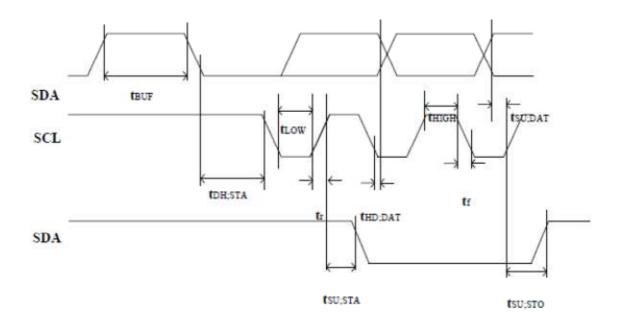
During the initialization, the following instructions are executed, and BF (Busy Flag) is kept "High" (busy state) to the end of initialization.

Clear Display Instruction Write "20H" to all DDRAM Set Functions Instruction DL = 1: 8-bit bus mode N = 0: 1-line display F = 0: 5 x 8 dot character font Display ON/OFF Instruction D = 0: Display OFF C = 0: Cursor OFF B = 0: Blink OFF Set Entry Mode Instruction I/D = 1: Increment by 1 S = 0: No entire display shift Note:

If the electrical characteristics conditions listed under the table Power Supply Conditions Using Internal Reset Circuit are not met, the internal reset circuit will not operate normally and will fail to initialize the Controller. For such a case, initialization must be performed by the MPU as explain by the following figure.

### **3. Timing Characteristics**

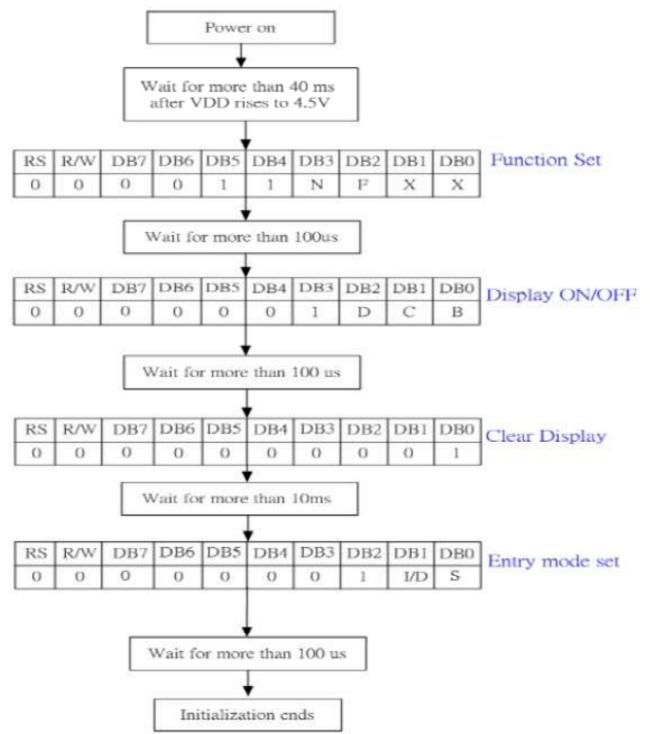
#### IIC interface timing



			Condition		( Ta				
Item	Signal	Symbol		VDD=2.7V		VDD=5V		Units	
				Min.	Max.	Min.	Max.		
SCL clock frequency		fscik		DC	400	DC	400	KHz	
SCL clock low period	SCL	tLow	1 -	1.3	_	1.3	_		
SCL clock high period	1	tHIGH		0.6	-	0.6	-	us	
Data set-up time	SDA	tsu:DAT		180		80		ns	
Data hold time	SDA	THD DAT		0	0.9	0	0.9	us	
SCL,SDA rise time	SCL,	t,		20+0.1C	300	20+0.1C+	300		
SCL,SDA fall time	SDA	t <sub>f</sub>		20+0.1C	300	20+0.1C.	300	ns	
Capacitive load represent by each bus line		Cb		3 <b>.</b>	400		400	pf	
Setup time for a repeated START condition	SDA	t <sub>SU,STA</sub>		0.6		0.6	-	us	
Start condition hold time		THD:STA		0.6		0.6	-	us	
Setup time for STOP condition		t <sub>SU;STO</sub>	-	0.6	-	0.6	-	us	
Bus free time between a Stop and START condition	SCL	t <sub>BUF</sub>	-	1.3		1.3	-	us	

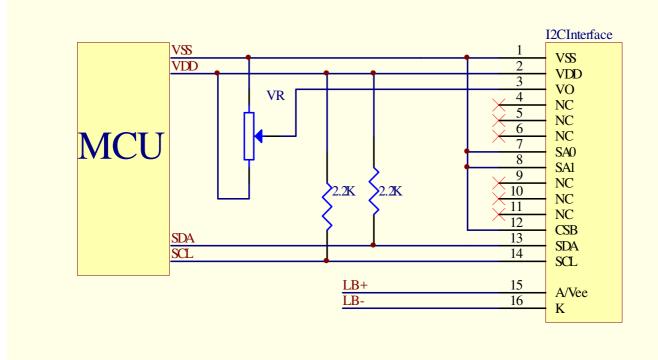
### 4.Initializing of LCM

#### Serial Interface Mode(Fosc=540KHz)



### 5. Recommended circuit diagram

Without negative voltage (Reference)



Build in negative voltage (Reference)

